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10645384 - GAI: 1715

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	Filing Date		2003-08-21
	First Named Inventor	Thomas Weiss et al.	
	Art Unit	1792	
	Examiner Name	Brian K. Talbot	
	Attorney Docket Number	FIS920030045US1	

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	7	6814804		2004-11-09	Onishi et al.	
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